

Fig. 1

- Series 830 single and double row interconnects have 2,0 spacing and permit board stacking as low as 8,18 .
- Pin headers (830 & 832) use MM# 5012 pins. (See page 166 for details)
- Sockets (831 & 833) use MM# 1802 receptacle accepts pin diameters from 0,38-0,64. (See page 138 for details)
- Insulators are high temperature thermoplastic, suitable for all soldering operations.

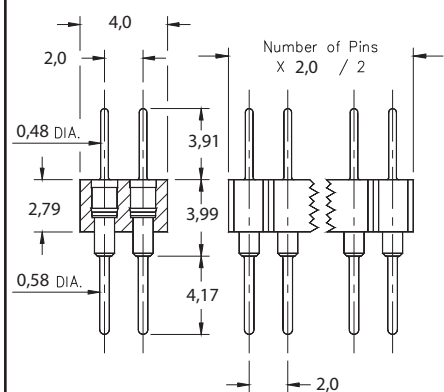


Fig. 2

Ordering Information

Fig. 1

Single Row Pin Header

830-XX-0__-10-001000
 Specify # of pins → 01-50

Fig. 2

Double Row Pin Header

832-XX-__-10-001000
 Specify # of pins → 002-100

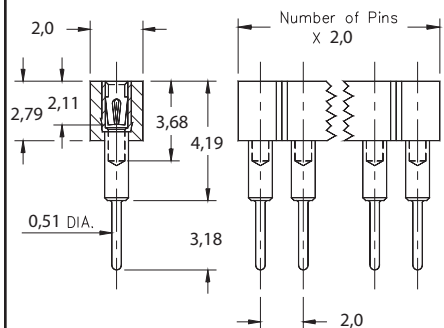


Fig. 3

Fig. 3

Single Row Socket

831-XX-0__-10-001000
 Specify # of pins → 01-50

Fig. 4

Double Row Socket

833-XX-__-10-001000
 Specify # of pins → 002-100

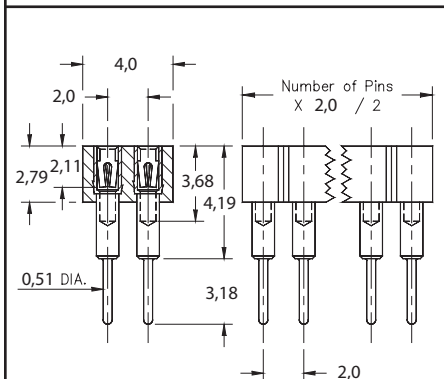


Fig. 4



*XX= Plating Code
 See Below*

SPECIFY PLATING CODE XX=	10◇	90	40◇	
Pin Plating	0,25µm Au	5,08µm Sn/Pb	5,08µm Sn	

Fig. 3	Single Row Socket			
	831-XX-0__-10-001000 Specify # of pins → 01-50			
Fig. 4	Double Row Socket			
	833-XX-__-10-001000 Specify # of pins → 002-100			



*XX= Plating Code
 See Below*

SPECIFY PLATING CODE XX=	13◇	93		43◇
Sleeve (Pin)	0,25µm Au	5,08µm Sn/Pb		5,08µm Sn
Contact (Clip)	0,76µm Au	0,76µm Au		0,76µm Au